

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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TECHNOLOGY CENTER 2800

Applicants: Hua Ji
Assignee: Mosel Vitelic, Inc.
Title: HDP CVD Process For Void-Free Gap Fill Of A High Aspect Ratio Trench
Serial No.: 10/080,468 Filing Date: February 22, 2002
Examiner: Anh D. Mai Group Art Unit: 2814
Docket No.: M-12589 US

Irvine, California
February 7, 2003

Attn: Group Director
COMMISSIONER FOR PATENTS
Washington, D. C. 20231

PETITION UNDER 37 C.F.R. § 1.97

Dear Sir:

This petition is to request consideration of the enclosed Information Disclosure Statement. Please charge \$130.00 to Deposit Account No. 50-2257. Please deduct any additional fees from, or credit any overpayment to the above-noted Deposit Account.

EXPRESS MAIL LABEL NO.:

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Respectfully submitted,

David S. Park

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